

# 1 Calibration

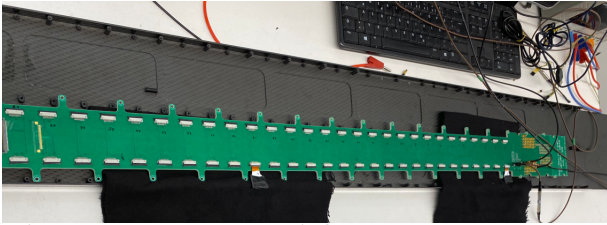
## 1.1 Ongoing Performance Monitoring

To ensure hardware component issues are detected early the system is supposed to be monitored by small LED's mounted in between the SiPM's. Short bursts of light injected into one side of the scintillator at a time will provide a stable signal source. Changes in the measured amplitude indicates either an efficiency loss in the scintillator or a gain drop of the involved SiPM's. These signals also act as a reference point in order to determine the time resolution of the detector elements while they are deployed.

It is foreseen to have four channels for all the LED's on one Rail-Board. This allows for every other LED on a single side along the board to be illuminated, leaving a dark scintillator between two illuminated scintillators. This ensures the signal is only produced by the internal light with no light bleed from a neighboring tile. By only illuminating one side

what is the benefit of this?

This method needs to be improved as tests have shown that the signals measured from both sides of the scintillator tile vary in intensity, although it was assumed that these LEDs would be used for accurate measurements. Figure 1 shows a time delay measurement.



**Figure 1: Tests with two LEDs on the board 1: signals measured at odd connectors 1 and 19 on the left side.**

Further, for calibration, we used such signal sources as Sr-90, Na-22, and a laser.

## 1.2 Position Calibration

In order to deliver useful position information for the detector hits the exact position of each tile in the context of the detector needs to be determined. The position of the individual scintillator tiles is mainly of interest in the context of the time resolution, signal delay and amplitude drop along the board which are discussed in the following sections.

this is probably done by in the commissioning phase of the detector setup for the whole experiment.

### 1.2.1 Time Resolution Expectancy along the Board

Since the time resolution is affected by signal noise and decreases of the slope of the rising flank it can be expected to receive a worse time resolution for scintillators farther down the Rail-Board with a longer distance between the detector element and the Front End Electronics. In order to create a baseline for the detector performance the time resolution needs to be measured along the length of the Rail-Board. Time resolution measurement gives excellent results of (50-100 ps) on the first part of the Rail-Board and unsatisfactory results of (300-400 ps) on the second part. In addition, distortions in the waveform during measurements were observed on the second part of the Rail-Board more often than on the first.

### 1.2.2 Signal Delay along the Board

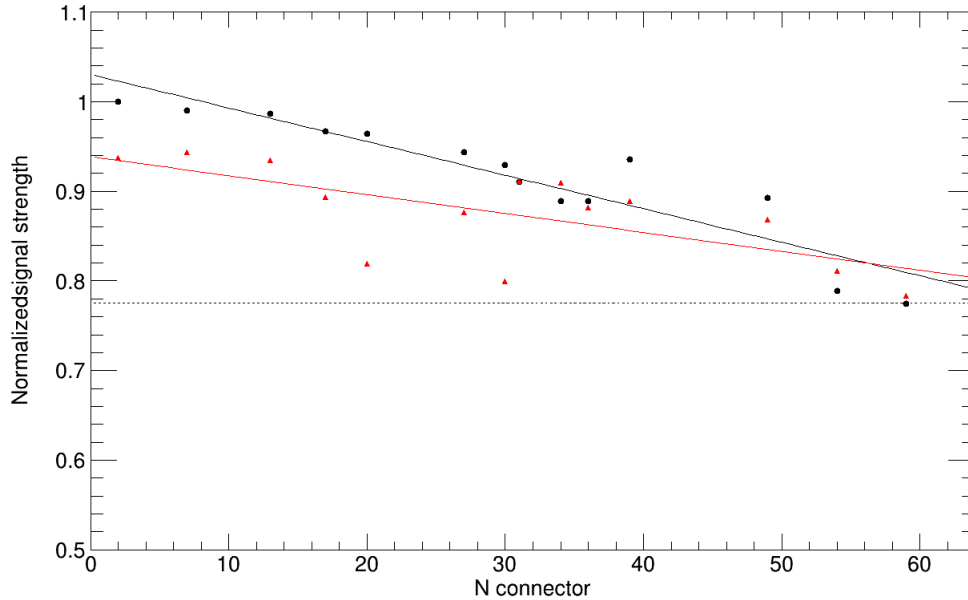
In order to provide an accurate time stamp for hits in the B-ToF detector the time a signal needs to travel from the SiPM's to the FEE has to be taken into account. The longer the electrical connection line is the larger the time delay between detector hit and time stamp in the electronics.

The speed a signal travels through a copper connection is significantly slower than the speed of light.

Comparison of the accumulated signal delay along the entire Rail-Board length (between slots 1 and 60) and the delay generated by a 2 m LEMO cable shows an excess of approx. 3 ns (12.5 ns vs 9.5 ns).

### 1.2.3 Amplitude Drop along the Board

Signal attenuation measurements have shown that a drop of up to 23% is expected for an internal connection of 2m length, which means a fairly strong amplitude drop (see Fig. 2).



From the measurement results, the following conclusions were drawn from a technical point of view:

1. Flexible PCBs, along with ease of use on the one hand, showed waveform distortion when bent, on the other hand.
2. In order to prevent the rapid destruction of the PCB with repeated bends due to the fragility of the wiring, the tests used the connection of the PCB with photodetectors using short wires.
3. Connectors along the boards for reading signals are reliable and convenient, gold connectors for read-out are also quite reliable, but not very firmly attached to the board.
4. External light affects measurements. In order to minimize this influence, the test setup was equipped with an insulating box.
5. There was no apparent jump in amplitude when switching from one board to another, associated with electrical connections, although signal distortions due to mechanical deformations of the flat cable (to ensure the connection of two boards) and the PCB occurred frequently, which led to a noticeable drop in amplitude.

6. Signal measurements on the second board showed an inconsistent signal amplitude change, likely related to the electrical wiring diagram.